

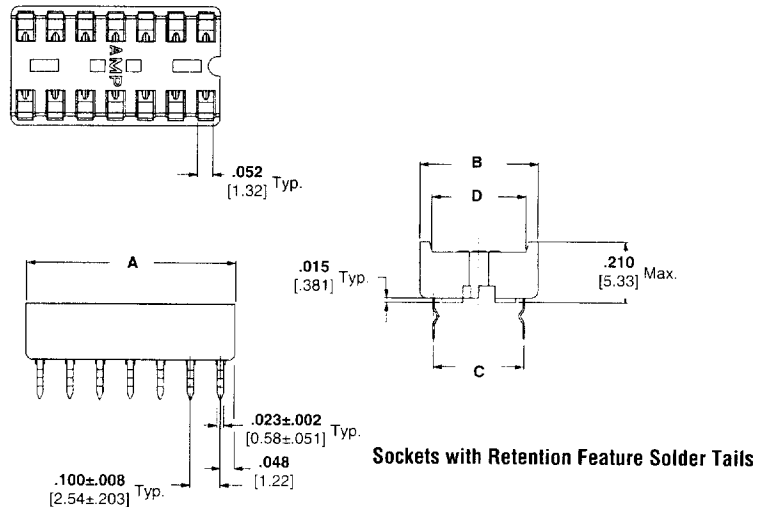
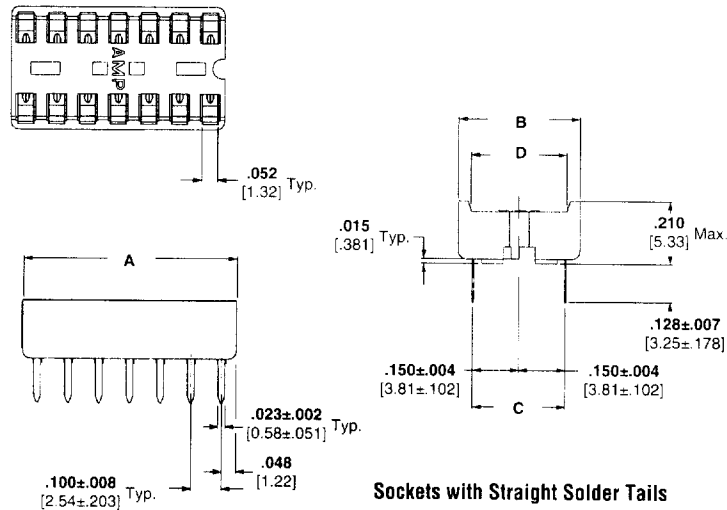
Dual Leaf (DL)

Sockets accept .008—.014
[0.2—0.36] thick IC leads

Material and Finish:

Housing — Glass-filled thermo-
plastic, 94V-0 rated, black

Contacts — Phosphor bronze
or beryllium copper with
tin or gold plating (see table)



No. of Positions	Dimensions				Sockets with Straight Solder Tails ¹		Sockets with Retention Solder Tails ¹		
	A	B	C	D	Beryllium Copper	Phosphor Bronze	Beryllium Copper	Phosphor Bronze	
					.000030 [0.00076] ² Gold Plate	.000015 [0.00038] ² Gold Plate	Tinned	Tinned	.000015 [0.00038] ² Gold Plate
14	.695 17.65	.394 10.01	.300 7.62	.320 8.13	—	2-640357-4	2-641261-1	—	—
16	.795 20.19	.394 10.01	.300 7.62	.320 8.13	2-640358-2	2-640358-4	2-641262-1	—	2-641262-4
18	.895 22.73	.394 10.01	.300 7.62	.320 8.13	—	2-640359-4	—	—	—
20	.995 25.27	.394 10.01	.300 7.62	.321 8.13	2-640464-2	2-640464-4	2-641264-1	—	2-641264-4
24	1.195 30.35	.694 17.63	.600 15.24	.620 15.75	2-640361-2	2-640361-4	2-641266-1	—	—
28	1.395 35.43	.694 17.63	.600 15.24	.620 15.75	2-640362-2	2-640362-4	2-641267-1	2-641267-3	2-641267-4
40	1.995 50.67	.694 17.63	.600 15.24	.620 15.75	2-640379-2	2-640379-4	2-641268-1	—	2-641268-4

¹ ONLY sockets with straight solder tails are recommended for automatic insertion. All parts are packaged in plastic tubes. Sockets with retention feature are packaged in plastic tubes for handling and storage convenience only.

² Gold thickness in contact area; tin-lead plate on solder tails.